

600V(D-S) N-Channel Enhancement Mode Power MOS FET

General Features

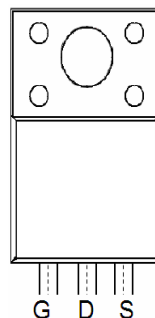
- $V_{DS} = 600V, I_D = 7A$
 $R_{DS(ON)} < 1.2 \Omega @ V_{GS} = 10V$
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability



Lead Free

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

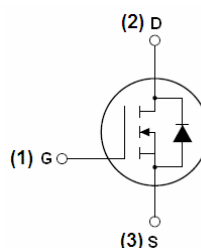


Marking and pin assignment

PIN Configuration



TO-220F top view



Schematic diagram

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| MSN6007F | MSN6007F | TO-220F-3L | - | - | - |

Absolute Maximum Ratings ($T_C = 25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|--------------------|------------|---------------|
| Drain-Source Voltage | V_{DS} | 600 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Drain Current-Continuous | I_D | 7 | A |
| Drain Current-Continuous($T_C = 100^\circ C$) | $I_D(100^\circ C)$ | 5.2 | A |
| Pulsed Drain Current | I_{DM} | 24 | A |
| Maximum Power Dissipation | P_D | 50 | W |
| Derating factor | | 0.4 | W/ $^\circ C$ |
| Single pulse avalanche energy ^(Note 5) | E_{AS} | 590 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 155 | $^\circ C$ |

Thermal Characteristic

| | | | |
|--|-----------------|-----|---------------|
| Thermal Resistance, Junction-to-Case ^(Note 2) | $R_{\theta JC}$ | 2.6 | $^{\circ}C/W$ |
|--|-----------------|-----|---------------|

Electrical Characteristics ($T_C=25^{\circ}C$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------|---|-----|------|-----------|----------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 600 | | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=600V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 30V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 2 | | 4 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=5.0A$ | - | 1.1 | 1.3 | Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=40V, I_D=3.5A$ | - | 6.2 | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=25V, V_{GS}=0V,$ $F=1.0MHz$ | - | 1120 | - | PF |
| Output Capacitance | C_{oss} | | - | 115 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 23 | - | PF |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=300V, I_D=7A, R_L=25\Omega$ $V_{GS}=10V, R_G=2.5\Omega$ | - | 30 | - | nS |
| Turn-on Rise Time | t_r | | - | 80 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 125 | - | nS |
| Turn-Off Fall Time | t_f | | - | 60 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=480V, I_D=7A,$ $V_{GS}=10V$ | - | 25 | | nC |
| Gate-Source Charge | Q_{gs} | | - | 6.0 | | nC |
| Gate-Drain Charge | Q_{gd} | | - | 10 | | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $V_{GS}=0V, I_S=7.0A$ | - | | 1.4 | V |
| Diode Forward Current ^(Note 2) | I_S | | - | - | 7.0 | A |
| Reverse Recovery Time | t_{rr} | $T_J = 25^{\circ}C, I_F = 7.0A$ $di/dt = 100A/\mu s$ ^(Note 3) | - | 315 | | nS |
| Reverse Recovery Charge | Q_{rr} | | - | 2.6 | | μC |
| Forward Turn-On Time | t_{on} | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. E_{AS} condition: $j=25^{\circ}C, V_{DD}=50V, V_G=10V, L=0.5mH, R_g=25\Omega$

Typical Electrical and Thermal Characteristics (Curves)

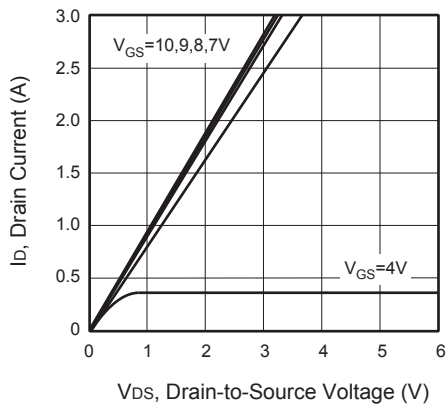


Figure 1. Output Characteristics

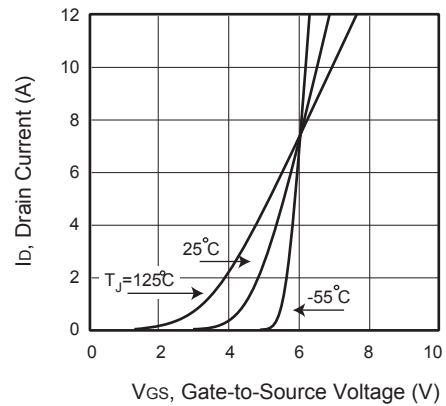


Figure 2. Transfer Characteristics

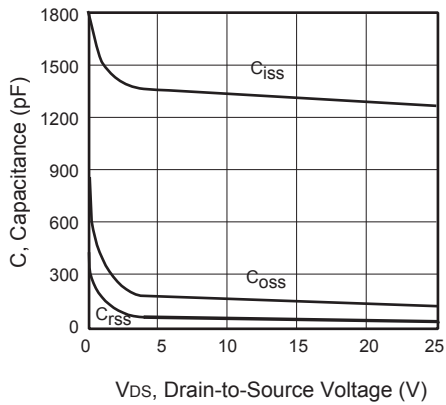


Figure 3. Capacitance

R
N
I
D

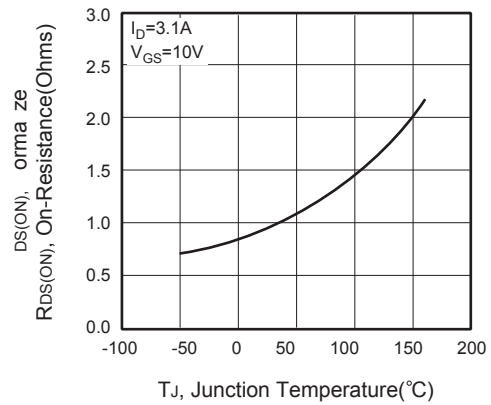


Figure 4. On-Resistance Variation with Temperature

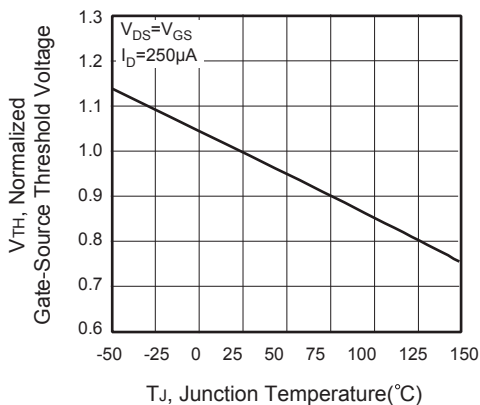


Figure 5. Gate Threshold Variation with Temperature

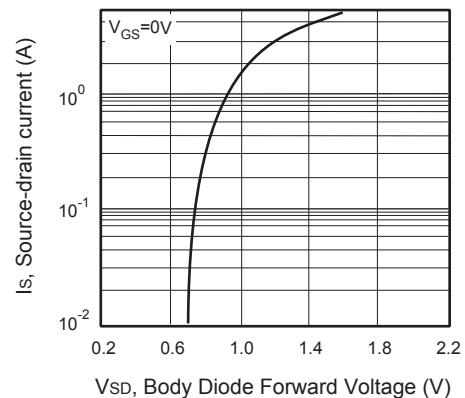


Figure 6. Body Diode Forward Voltage Variation with Source Current

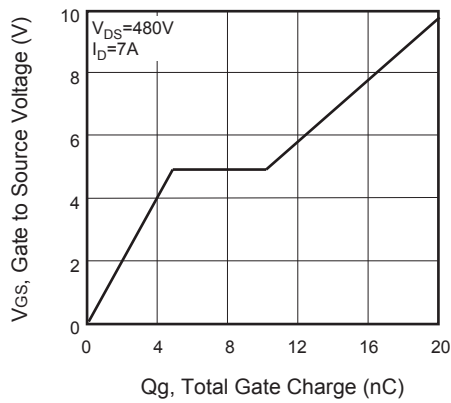


Figure 7. Gate Charge

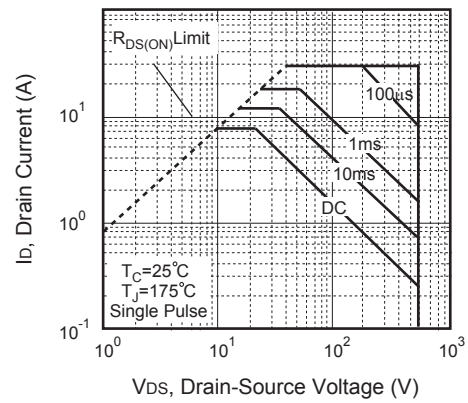


Figure 8. Maximum Safe Operating Area

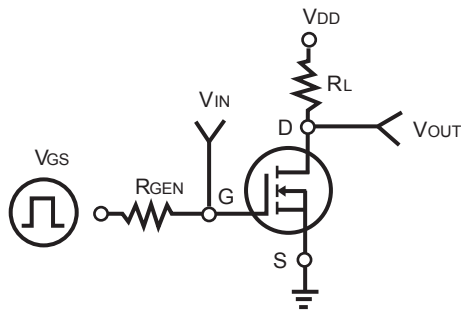


Figure 9. Switching Test Circuit

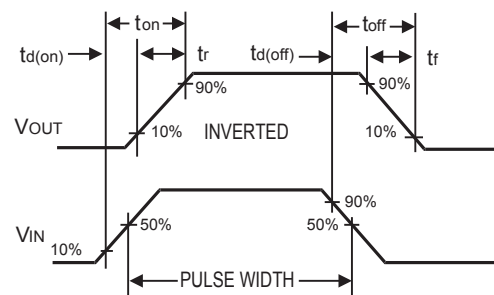


Figure 10. Switching Waveforms

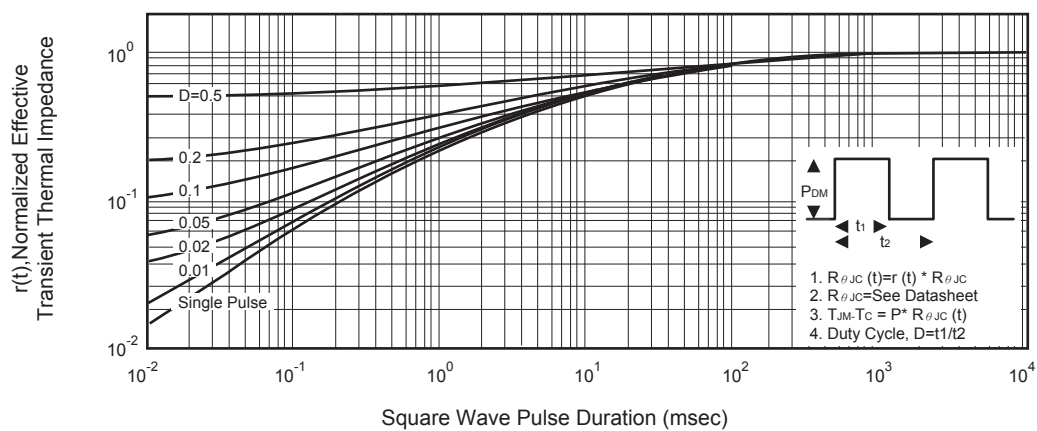
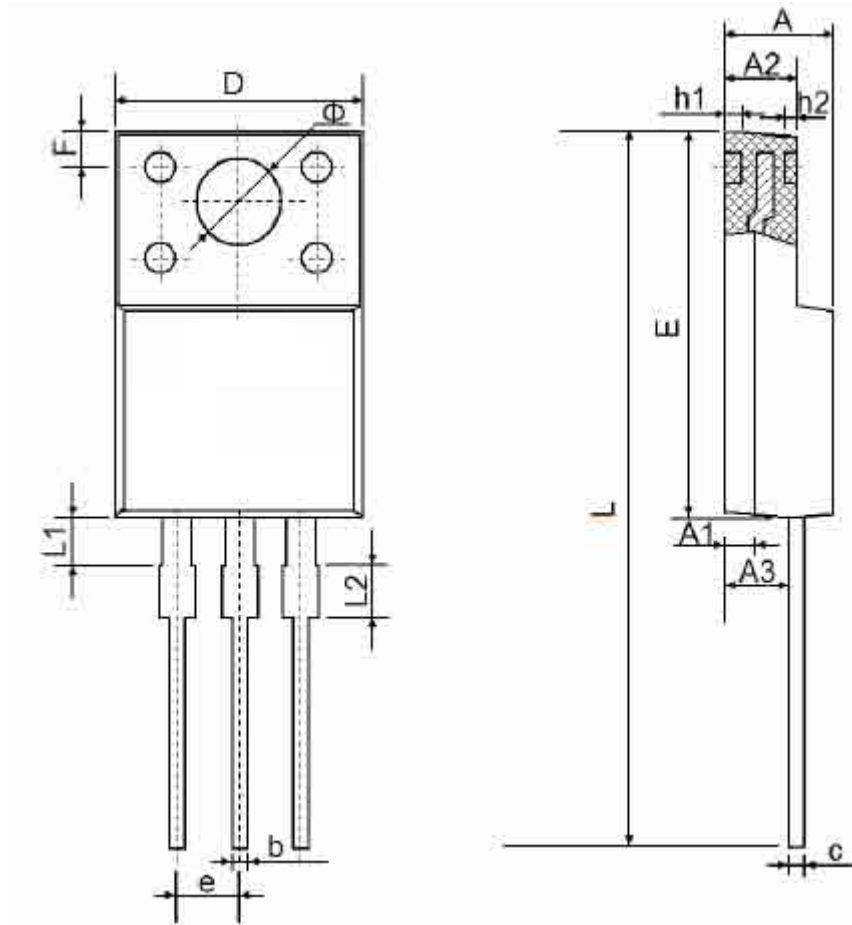


Figure 11. Normalized Thermal Transient Impedance Curve

TO-220F-3L Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 4.300 | 4.700 | 0.169 | 0.185 |
| A1 | 1.300REF | | 0.051REF | |
| A2 | 2.800 | 3.200 | 0.110 | 0.126 |
| A3 | 2.500 | 2.900 | 0.098 | 0.114 |
| b | 0.500 | 0.750 | 0.020 | 0.030 |
| b1 | 1.100 | 1.350 | 0.043 | 0.053 |
| b2 | 1.500 | 1.750 | 0.059 | 0.069 |
| c | 0.500 | 0.750 | 0.020 | 0.030 |
| D | 9.960 | 10.360 | 0.392 | 0.408 |
| E | 14.800 | 15.200 | 0.583 | 0.598 |
| e | 2.540TYP. | | 0.100TYP | |
| F | 2.700REF | | 0.106REF | |
| Φ | 3.500REF | | 0.138REF | |
| h1 | 0.800REF | | 0.031REF | |
| h2 | 0.500REF | | 0.020REF | |
| L | 28.000 | 28.400 | 1.102 | 1.118 |
| L1 | 1.700 | 1.900 | 0.067 | 0.075 |
| L2 | 1.900 | 2.100 | 0.075 | 0.083 |